

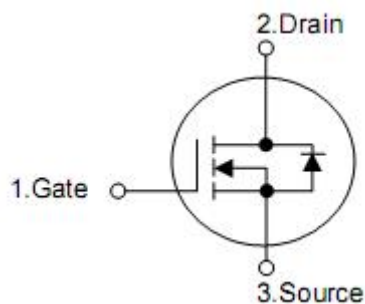
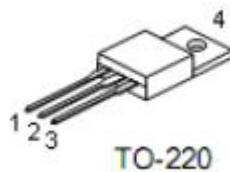
1. Features

- n $R_{DS(on)}$ (TYP)= 2.2m Ω @ V_{GS} = 10 V
- n Lead free and green device available
- n Low Rds-on to minimize conductive loss
- n High avalanche current

2. Applications

- n Power supply
- n DC-DC converters

3. Pin configuration



| Pin | Function |
|-----|----------|
| 1 | Gate |
| 2 | Drain |
| 3 | Source |
| 4 | Drain |

4. Ordering Information

| Part Number | Package | Brand |
|-------------|---------|-------|
| KNP2404A | TO-220 | KIA |

5. Absolute maximum ratings

| Parameter | | Symbol | Maximum | Units |
|--------------------------------------|---|----------------|----------|------------------|
| Drain-to-source voltage | | V_{DSS} | 40 | V |
| Gate-to-source voltage | | V_{GSS} | ± 25 | V |
| Continuous drain current | $T_C=25^\circ\text{C}$ (Silicon limited) | I_D | 190 | A |
| | $T_C=25^\circ\text{C}$ (Package limited) | | 120 | |
| | $T_C=100^\circ\text{C}$ (Silicon limited) | | 109 | |
| Pulsed drain current | $T_C=25^\circ\text{C}$ | I_{DP} | 480 | A |
| Avalanche current(L=0.5mH) | | I_{AS} | 46 | A |
| Avalanche energy(L=0.5mH) | | E_{AS} | 529 | mJ |
| Maximum power dissipation | $T_C=25^\circ\text{C}$ | P_D | 123 | W |
| | $T_C=100^\circ\text{C}$ | | 82 | W |
| Junction & storage temperature range | | T_J, T_{STG} | -55~150 | $^\circ\text{C}$ |

*Drain current limited by maximum junction temperature.

6. Thermal characteristics

| Parameter | Symbol | Typical | Units |
|--|-----------------|---------|---------------------------|
| Thermal resistance-junction to case | $R_{\theta jc}$ | 1.02 | $^\circ\text{C}/\text{W}$ |
| Thermal resistance-junction to ambient | $R_{\theta ja}$ | 80 | |

7. Electrical characteristics

($T_A=25^\circ\text{C}$, unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|--|--------------|--|-----|------|-----------|------------|
| Static characteristics | | | | | | |
| Drain-source breakdown voltage | BV_{DSS} | $V_{GS}=0V, I_{DS}=250\mu A$ | 40 | - | - | V |
| Zero gate voltage drain current | I_{DSS} | $V_{DS}=64V, V_{GS}=0V$ | - | - | 1 | μA |
| Gate threshold voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_{DS}=250\mu A$ | 2 | - | 4 | V |
| Gate leakage current | I_{GSS} | $V_{GS}=\pm 25V, V_{DS}=0V$ | - | - | ± 100 | nA |
| Drain-source on-state resistance | $R_{DS(on)}$ | $V_{GS}=10V, I_{DS}=30A$ | - | 2.2 | 3.5 | m Ω |
| Forward Transconductance | G_{fs} | $V_{DS}=5V, I_D=40A$ | - | 135 | - | S |
| Diode characteristics | | | | | | |
| Diode forward voltage | V_{SD} | $I_{SD}=40A, V_{GS}=0V$ | - | 0.9 | 1.3 | V |
| Diode continuous forward current | I_S | | - | - | 190 | A |
| Reverse recovery time | t_{rr} | $I_S=40A, di/dt=100A/\mu s$ | - | 55 | - | nS |
| Reverse recovery charge | Q_{rr} | | - | 70 | - | nC |
| Dynamic characteristics ² | | | | | | |
| Gate resistance | R_G | $V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$ | - | 2.0 | - | Ω |
| Input capacitance | C_{iss} | $V_{GS}=0V, V_{DS}=25V, F=1.0\text{MHz}$ | - | 6010 | - | pF |
| Output capacitance | C_{oss} | | - | 1400 | - | |
| Reverse transfer capacitance | C_{rss} | | - | 675 | - | |
| Turn-on delay time | $t_{d(ON)}$ | $V_{DD}=25V, I_D=90A, V_{GS}=10V, R_G=2.7\Omega$ | - | 25 | - | nS |
| Turn-on rise time | t_r | | - | 102 | - | |
| Turn-off delay time | $t_{d(OFF)}$ | | - | 62 | - | |
| Turn-off fall time | t_f | | - | 84 | - | |
| Gate charge characteristics ² | | | | | | |
| Total gate charge | Q_g | $V_{DS}=40V, V_{GS}=10V, I_D=32A, F=1.0\text{MHz}$ | - | 150 | - | nC |
| Gate-to-source charge | Q_{gs} | | - | 32 | - | |
| Gate-to-drain charge | Q_{gd} | | - | 70 | - | |

8. Test circuits and waveforms

Fig 1: Output Characteristics

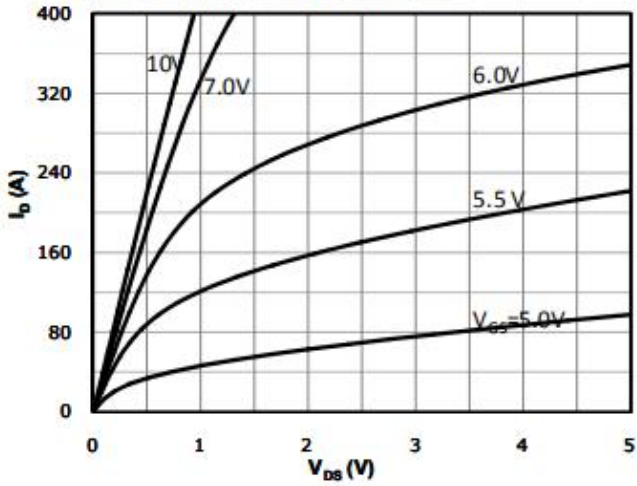


Fig 2: Transfer Characteristics

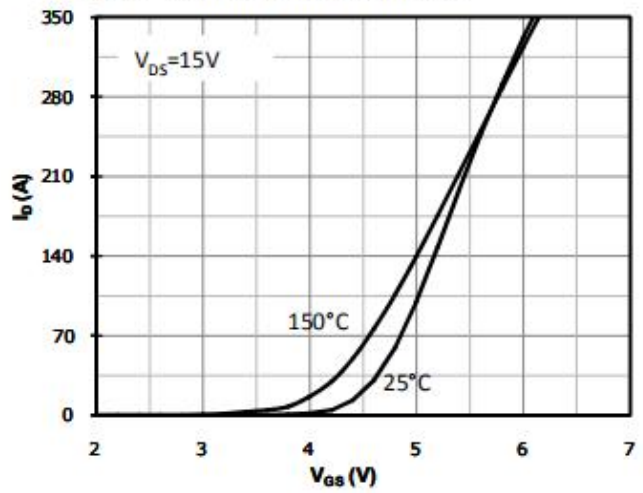


Fig 3: Rds(on) vs Drain Current and Gate Voltage

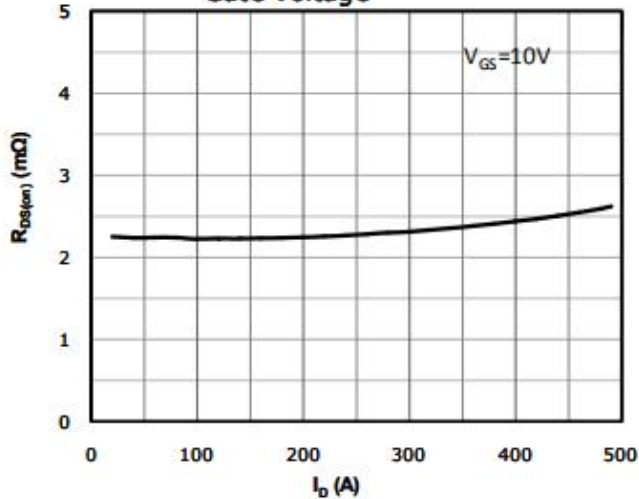


Fig 4: Rds(on) vs Gate Voltage

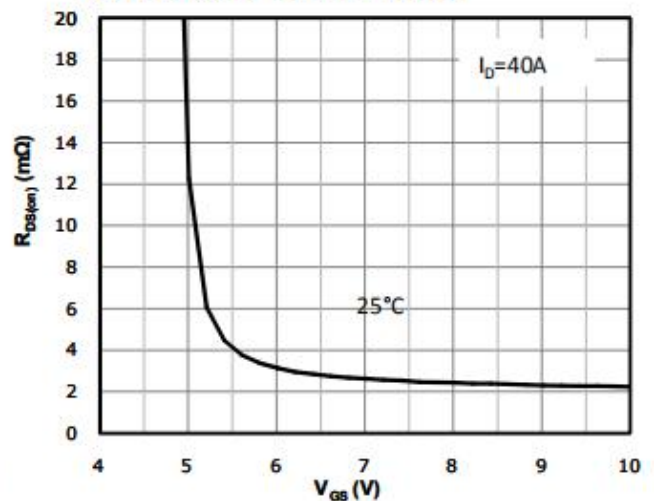


Fig 5: Rds(on) vs. Temperature

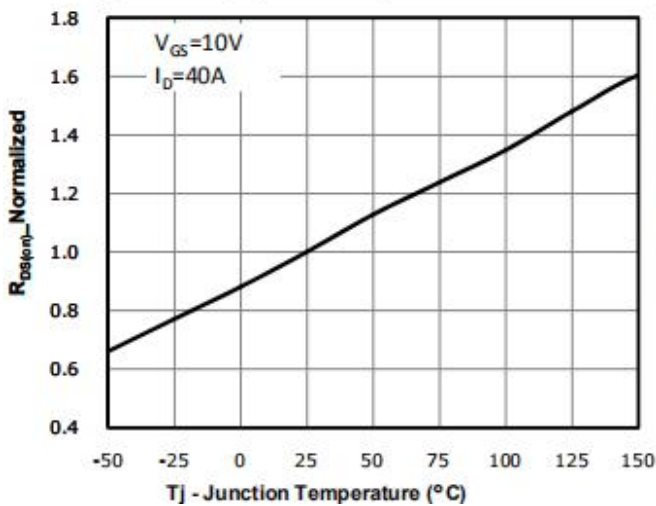


Fig 6: Capacitance Characteristics

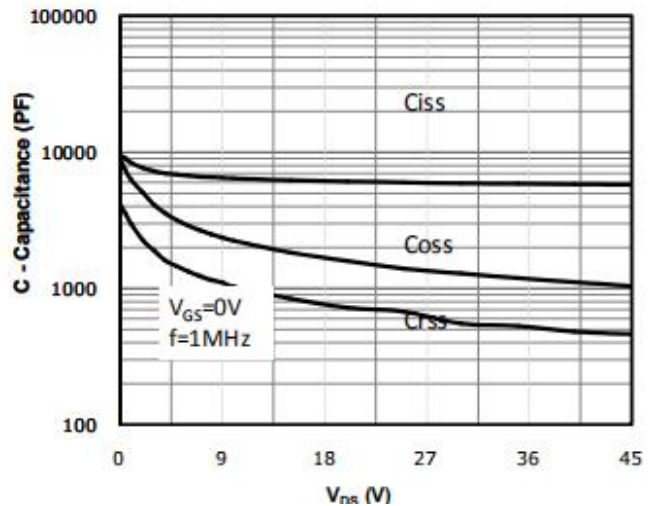


Fig 7: Gate Charge Characteristics

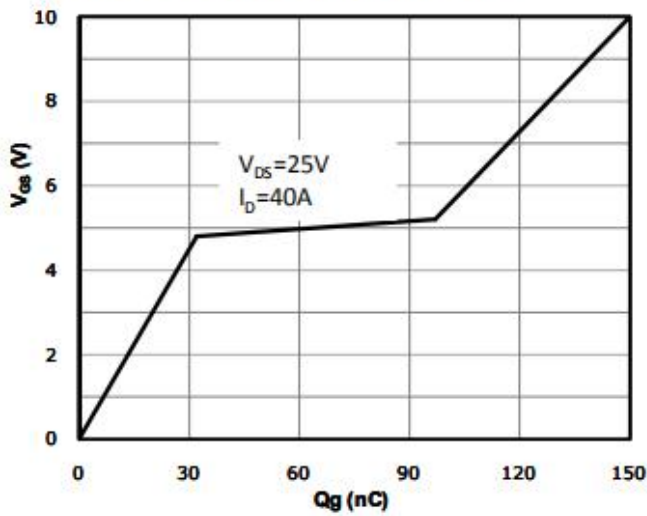


Fig 8: Body-diode Forward Characteristics

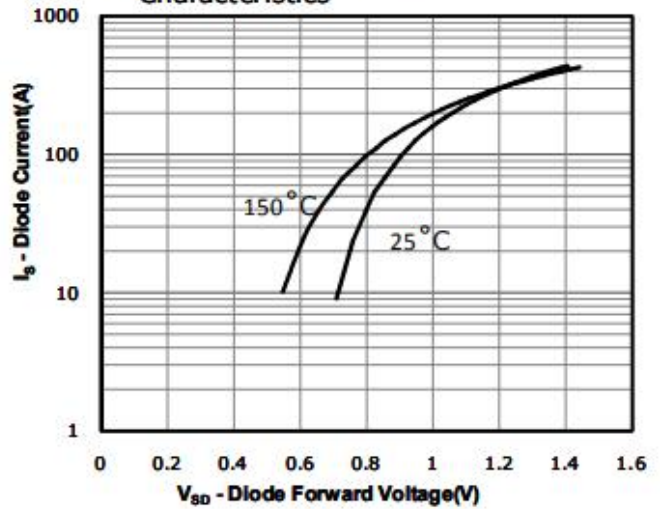


Fig 9: Power Dissipation

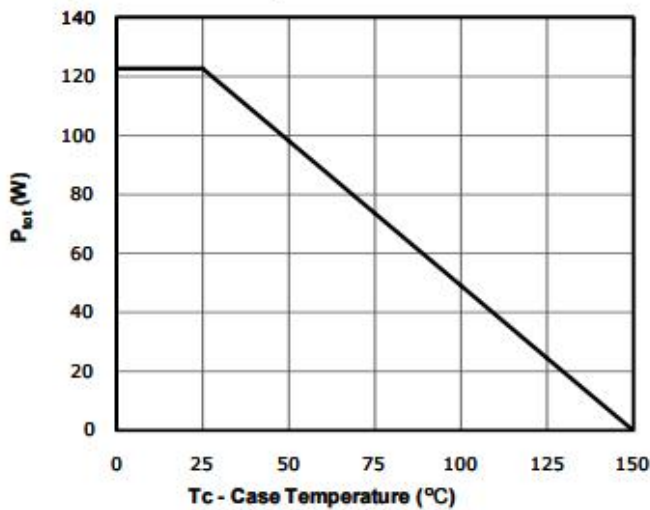


Fig 10: Drain Current Derating

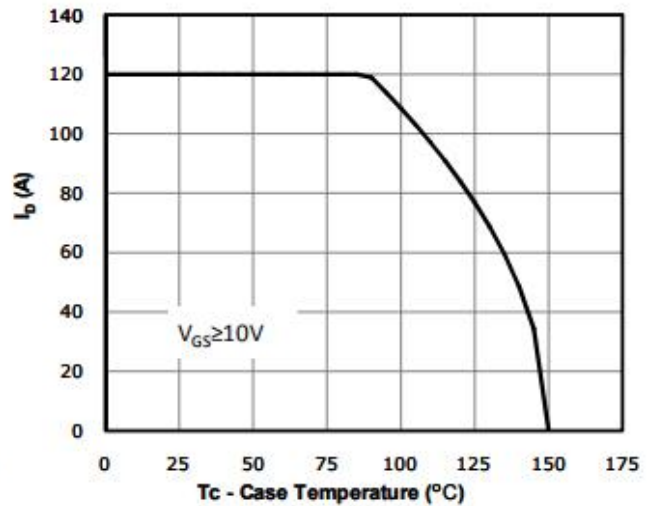


Fig 11: Safe Operating Area

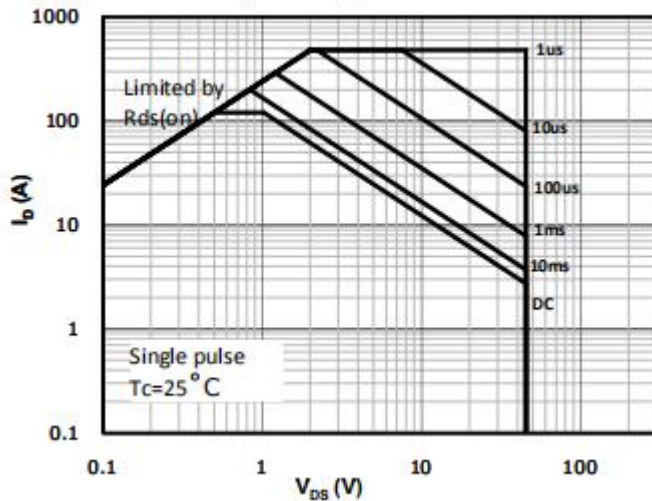
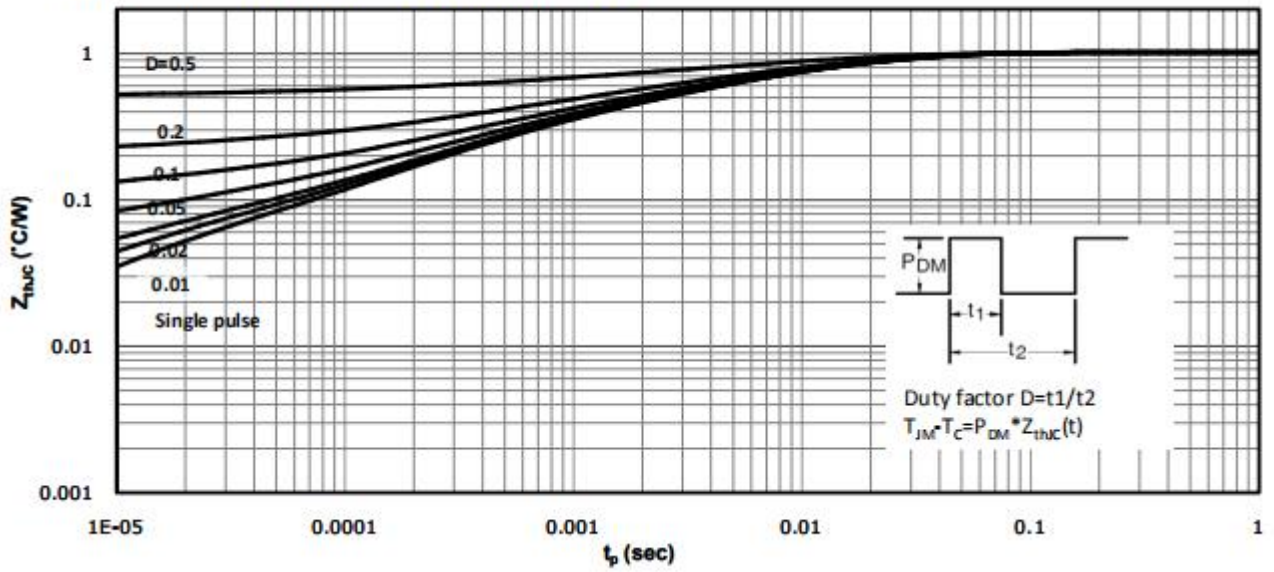


Fig 12: Max. Transient Thermal Impedance



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